

## **TYS -Low Profile SMT Power Inductor**

**TYS5040** Series

#### **FEATURES** AND APPLICATIONS

Laird TYS series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics, industrial and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and wire wound construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

#### **FEATURES**

- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and small size
- Ferrite core with high saturation

#### **APPLICATIONS**

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



#### PART NUMBER EXPLANATION



Product series code

Product size code

value code (i.e. 4R7: 4.7

Tolerance % Standard (i.e. M:  $\pm$  20%) Catalog P.N

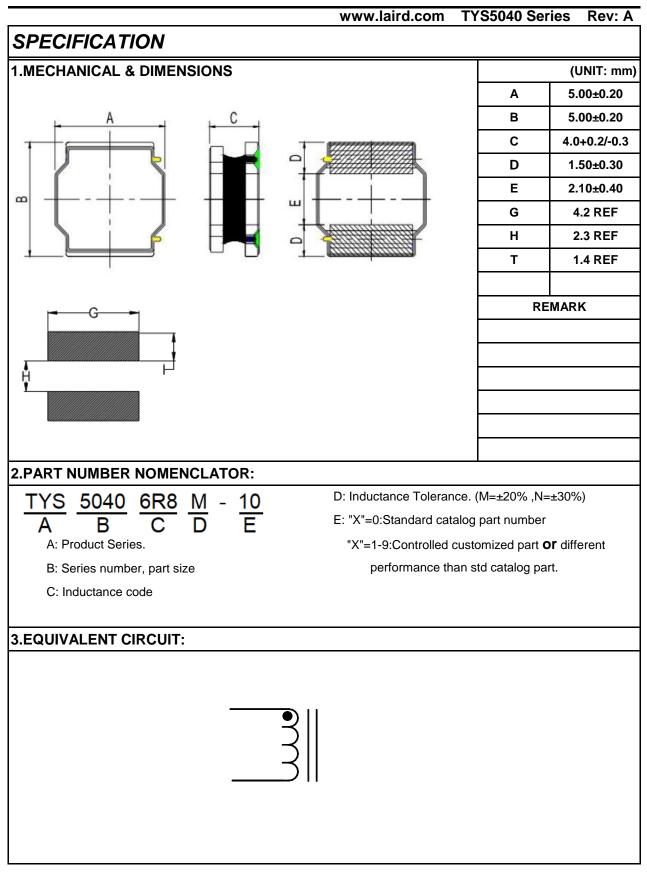
#### **ELECTRICAL SPECIFICATIONS**

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 1MHz, 1.0Vrms
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 70%(MAX.)

**Note:** Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air. The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



**Laird Performance Materials** 

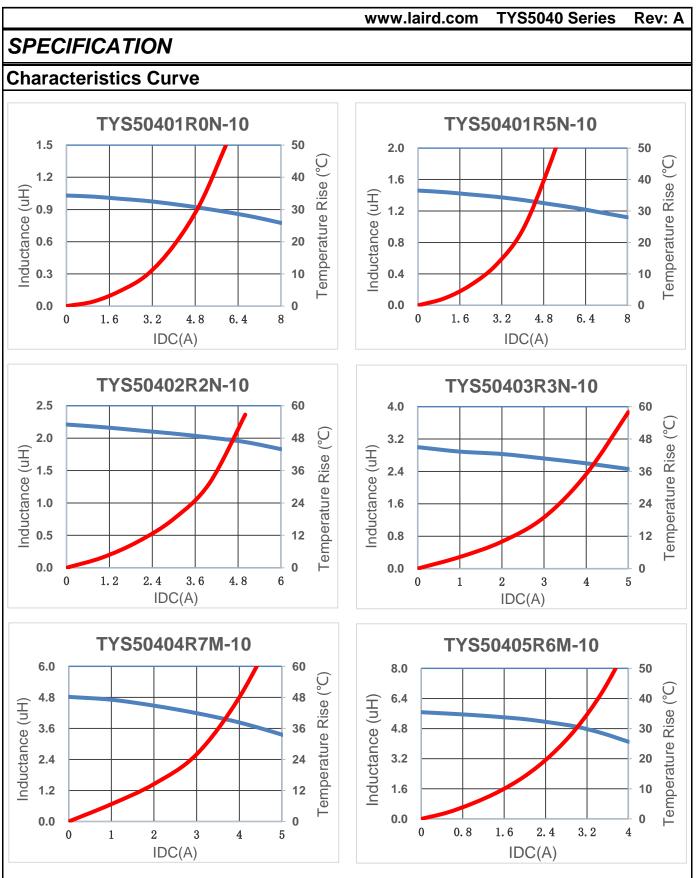




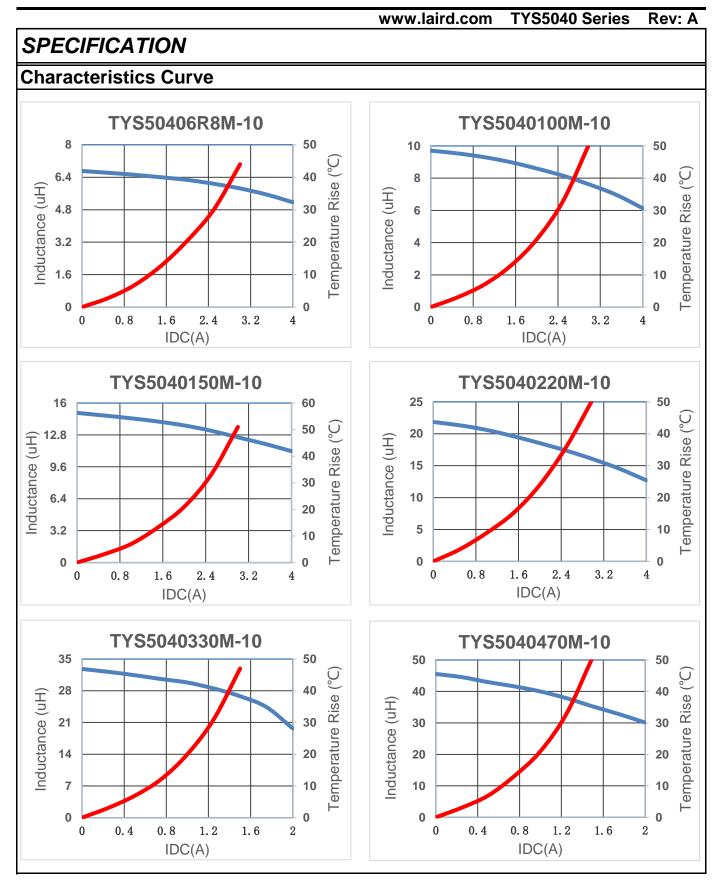
			www.laii	d.com TY	S5040 Series	Rev: A
SPECIFICAT	ION					
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) TYP	DCR(mΩ) Max	SRF MHz
TYS50401R0N-10	1.00	4.90	7.35	12.00	14.4	117
TYS50401R5N-10	1.50	4.30	6.30	15.00	18.0	85
TYS50402R2N-10	2.20	3.80	4.90	19.00	22.8	50
TYS50403R3N-10	3.30	3.40	3.95	24.00	28.8	32
TYS50404R7M-10	4.70	3.00	3.50	30.00	36.0	28
TYS50405R6M-10	5.60	2.80	3.00	38.00	46.0	27
TYS50406R8M-10	6.80	2.50	2.90	43.00	51.6	21
TYS5040100M-10	10.00	2.30	2.70	47.80	62.0	20
TYS5040150M-10	15.00	2.00	2.00	86.00	103.0	13
TYS5040220M-10	22.00	1.50	1.60	129.00	155.0	11
TYS5040330M-10	33.00	1.20	1.30	188.00	226.0	9.1
TYS5040470M-10	47.00	1.00	1.10	272.00	326.0	6.7
TYS5040680M-10	68.00	0.80	0.90	400.00	480.0	5.7
TYS5040101M-10	100.00	0.70	0.75	560.00	672.0	4.7
GENERAL SPECI	FICATION:					
• Tolerance: M: ±20%	% or N: ±30%					
<ul> <li>Inductance tested a</li> </ul>	at 100KHz, 1.0V	rms				
<ul> <li>Heat Rated Current</li> </ul>	: (Irms) is define	d based on ten	nperature rise a	opproximate 40	°C	
(ambient temperat	ure 25±5°C)					
• Saturation Current	(Isat) is the DC	current at whic	h the inductand	e drops off app	roximately 30%	1
from its value with	out current. (am	ibient tempera	ture 25±5°C)			
<ul> <li>Operating tempera</li> </ul>	ture range: -40°	°C~+125°C (incl	uding self-heat	ing temperatur	e rise)	
Storage temperature	re range (packa	ging conditions	): -10°C~+40°C	and RH 70%(M	4X.)	



**Shielded Power Inductor** 





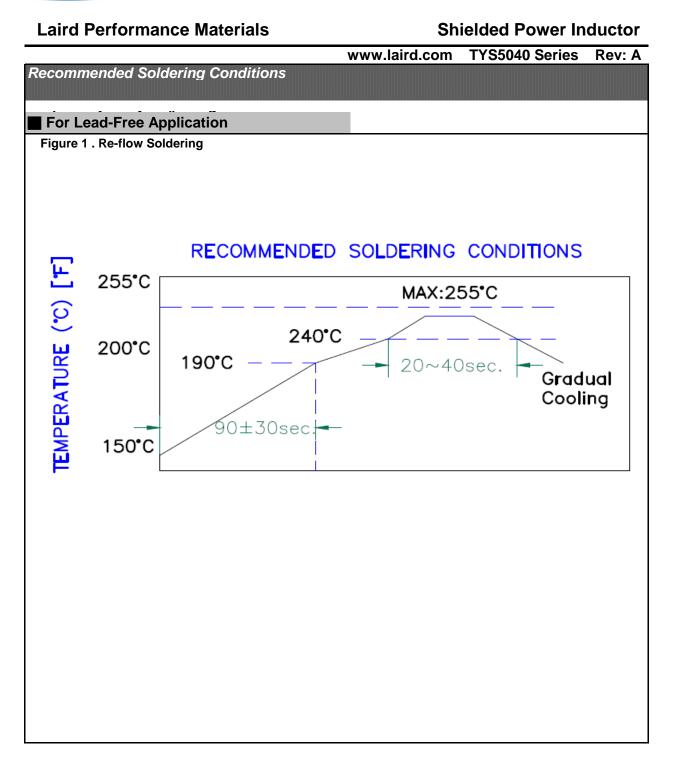




#### **Shielded Power Inductor**

#### TYS5040 Series www.laird.com Rev: A **SPECIFICATION Characteristics Curve TYS5040680M-10 TYS5040101M-10** 70 60 100 60 °C) () 0 50 50 80 56 Inductance (uH) **Temperature Rise** Inductance (uH) Temperature Rise 40 40 60 42 30 30 40 28 20 20 14 20 10 10 0 0 0 0 0 0.3 0.6 0.9 1.2 1.5 0 0.3 0.6 0.9 1.2 1.5 IDC(A) IDC(A)







	W	ww.laird.com TYS5040 Series Rev: A						
Reliability and Te	sting Conditions / Pin Type Po	wer Inductors						
SMD series(Consumer)								
Item	Reference	Additional Requirements						
Operating temperature range	-40°C ~ +125°C (Including self-temperature rise)							
Storage temperature and humidity range	-10 $^\circ\!\mathbb{C}$ to +40 $^\circ\!\mathbb{C}$ , 70% RH Max							
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours						
Temperature Cycling	JESD22 Method JA-104	-40 <sup>°</sup> C→+85, transforming interval:20s, 100cycles						
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing						
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrica Test not required.						
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required						
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)						
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5℃,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu						
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu						
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures						
Board Flex	AEC-Q200-005	2mm,30±1s						
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct						



**Shielded Power Inductor** 

	www.laird.com	TYS5040 Serie	es Rev: A			
PACKAGING						
Reel Dimension						
	A(m B(m C(m D(m	100 REF 13 REF				
Tape Dimension						
	P2 T	D				
12.0±0.3 5.5±0.1 1.75±0.1 4.0±0.1 2.0±0		1.5±0.1				
Packaging Quantity						
P/N Chip/Reel						
TYS5040 series 1500pcs						
Peeling Off Force						
165°~180°     The force peeling off cove tape is 10 to 100 grams						
	the arrow direction under	v				
	Room Room Humidity Temp (%)	(hPa)	eaming Speed (mm/min)			
Top cover tape	5~35 45~85	860~1060	300			
<ul> <li>Storage Conditions</li> <li>1. Temperature and humidity conditions: -10-+40°C and 70% RH.</li> <li>2. Recommended products should be used within 12 mon from the time of manufacturing.</li> <li>3. The packaging material should be kept where no chlorin</li> </ul>						
or sulfur exists in the air.						

or sulfur exists in the air.

4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Laird Performance Materials: TYS5040470M-10